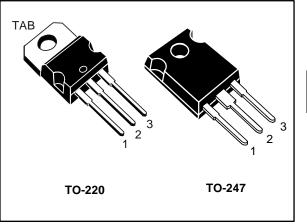
STP26N60M2, STW26N60M2

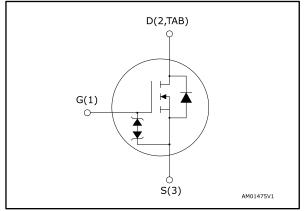
N-channel 600 V, 0.14 Ω typ., 20 A MDmesh $^{\rm TM}$ M2 Power MOSFETs in TO-220 and TO-247 packages

Datasheet - production data



life.augmented

Figure 1: Internal schematic diagram



Features

Order code	V _{DS} @ T _{Jmax}	R _{DS(on)} max.	ID	Ρτοτ
STP26N60M2	CEO V	0.165.0	20.4	160 W/
STW26N60M2	650 V	0.165 Ω	20 A	169 W

- Extremely low gate charge
- Excellent output capacitance (Coss) profile
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

These devices are N-channel Power MOSFETs developed using MDmesh[™] M2 technology. Thanks to their strip layout and improved vertical structure, these devices exhibit low on-resistance and optimized switching characteristics, rendering them suitable for the most demanding high efficiency converters.

Table 1: Device summary

Order code	Marking	Package	Packing
STP26N60M2	OCN/COMO	TO-220	Tuba
STW26N60M2	26N60M2	TO-247	Tube

DocID028178 Rev 2

This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vgs	Gate-source voltage	±25	V
	Drain current (continuous) at T _{case} = 25 °C	20	А
lo	Drain current (continuous) at T _{case} = 100 °C	13	A
IDM ⁽¹⁾	Drain current (pulsed)	80	А
Ртот	Total dissipation at T _{case} = 25 °C	169	W
dv/dt ⁽²⁾	Peak diode recovery voltage slope	15	V/ns
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	50	V/115
T _{stg}	Storage temperature range	-55 to 150	°C
Tj	Operating junction temperature range	-55 10 150	C

Notes:

 $^{\left(1\right) }$ Pulse width is limited by safe operating area.

 $^{(2)}$ I_{SD} ≤ 20 A, di/dt=400 A/µs; V_{DS(peak)} < V_{(BR)DSS}, V_DD = 80% V_{(BR)DSS}.

⁽³⁾ $V_{DS} \le 480 \text{ V}.$

Table 3: Thermal data

Symbol	Parameter	Va	lue	Unit
Symbol	Falameter	TO-220	TO-247	Onit
R _{thj-case}	Thermal resistance junction-case	0.	74	°C/W
$R_{thj-amb}$	Thermal resistance junction-ambient	62.5	50	°C/W

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
lar ⁽¹⁾	Avalanche current, repetitive or not repetitive	3.8	А
E _{AS} ⁽²⁾	Single pulse avalanche energy	250	mJ

Notes:

 $^{\left(1\right) }$ Pulse width limited by $T_{jmax}.$

 $^{(2)}$ starting T_{j} = 25 °C, I_{D} = $I_{AR},\,V_{DD}$ = 50 V.



2 Electrical characteristics

(T_{case} = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 V$, $I_D = 1 mA$	600			V
	Zoro goto voltago droin	$V_{GS} = 0 V, V_{DS} = 600 V$			1	
IDSS	Zero gate voltage drain current	$V_{GS} = 0 V, V_{DS} = 600 V,$ $T_{case} = 125 \ ^{\circ}C^{(1)}$			100	μA
Igss	Gate-body leakage current	$V_{DS} = 0 V$, $V_{GS} = \pm 25 V$			±10	μA
VGS(th)	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	2	3	4	V
R _{DS(on)}	Static drain-source on- resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$		0.14	0.165	Ω

Notes:

 $\ensuremath{^{(1)}}\xspace$ Defined by design, not subject to production test.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	1360	-	
Coss	Output capacitance	$V_{DS} = 100 V$, f = 1 MHz,	-	88	-	pF
C _{rss}	Reverse transfer capacitance	V _{GS} = 0 V	-	2	-	2
Coss eq. ⁽¹⁾	Equivalent output capacitance	V_{DS} = 0 to 480 V, V_{GS} = 0 V	-	124	-	pF
Rg	Intrinsic gate resistance	$f = 1 \text{ MHz}, I_D = 0 \text{ A}$	-	4	-	Ω
Qg	Total gate charge	$V_{DD} = 480 \text{ V}, \text{ I}_{D} = 20 \text{ A},$	-	34	-	
Qgs	Gate-source charge	V _{GS} = 10 V (see Figure 17: "Test circuit for gate charge	-	5.6	-	nC
Q _{gd}	Gate-drain charge	behavior")	-	16.3	-	

Table 6: Dynamic

Notes:

 $^{(1)}$ Coss eq. is defined as a constant equivalent capacitance giving the same charging time as Coss when VDS increases from 0 to 80% VDSS.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD}=300~V,~I_{D}=10~A~R_{G}=4.7~\Omega,$	-	20.2	-	
tr	Rise time	V _{GS} = 10 V (see Figure 16: "Test circuit for resistive load switching	-	8	-	
t _{d(off)}	Turn-off delay time	times" and Figure 21: "Switching	-	66	-	ns
tſ	Fall time	time waveform")	-	10	-	

Table 7: Switching times



STP26N60M2, STW26N60M2

Electrical characteristics

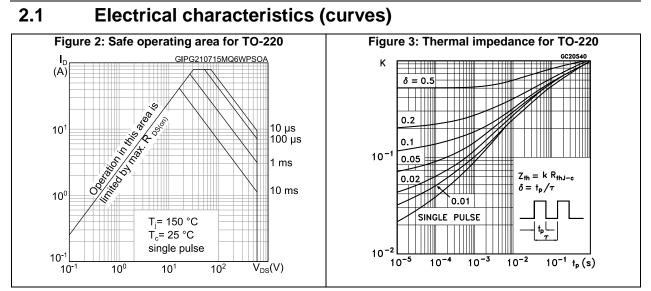
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	Tal	ble 8: Source-drain diode	i			
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Isd	Source-drain current		-		20	А
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		80	А
Vsd ⁽²⁾	Forward on voltage	V_{GS} = 0 V, I_{SD} = 20 A	-		1.6	V
trr	Reverse recovery time	I _{SD} = 20 A, di/dt = 100 A/µs,	-	360		ns
Qrr	Reverse recovery charge	V _{DD} = 60 V (see Figure 18: "Test circuit for inductive load	-	5		μC
I _{RRM}	Reverse recovery current	switching and diode recovery times")	-	27		А
trr	Reverse recovery time	I _{SD} = 20 A, di/dt = 100 A/µs,	-	556		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, \text{ T}_{j} = 150 \text{ °C}$ (see Figure 18: "Test circuit for	-	8		μC
Irrm	Reverse recovery current	inductive load switching and diode recovery times")	-	29		A

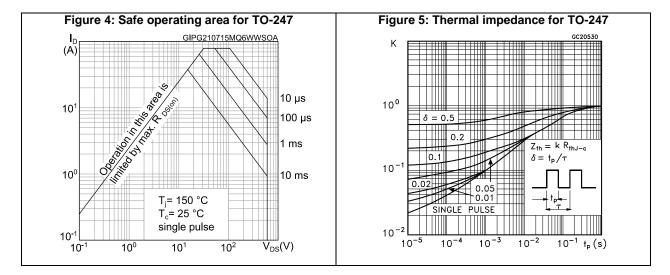
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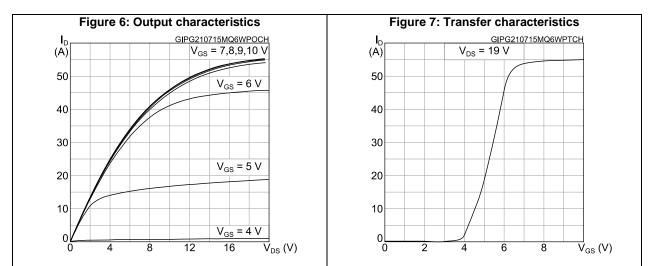
 $^{\left(1\right) }$ Pulse width is limited by safe operating area.

 $^{(2)}$ Pulse test: pulse duration = 300 $\mu s,$ duty cycle 1.5%.









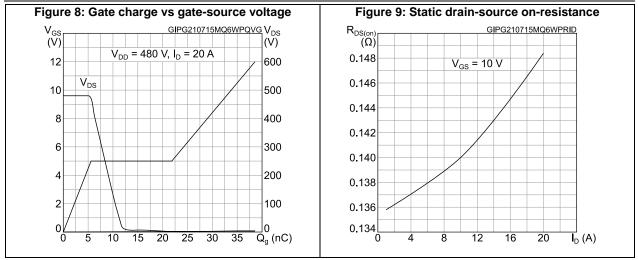
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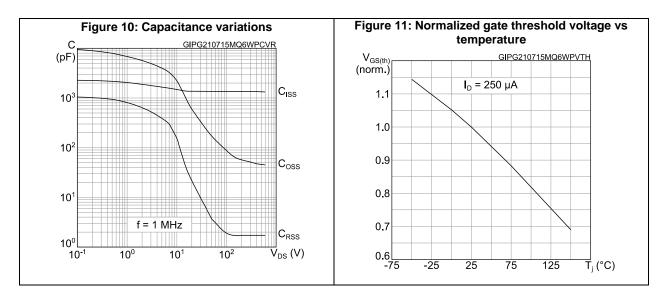


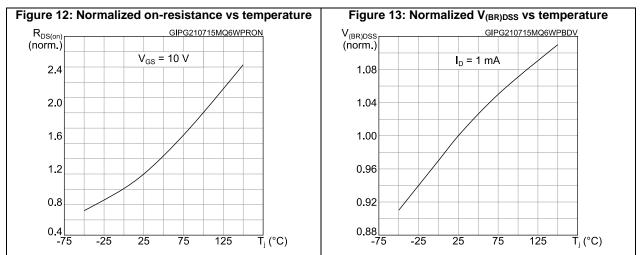
STP26N60M2, STW26N60M2

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Electrical characteristics

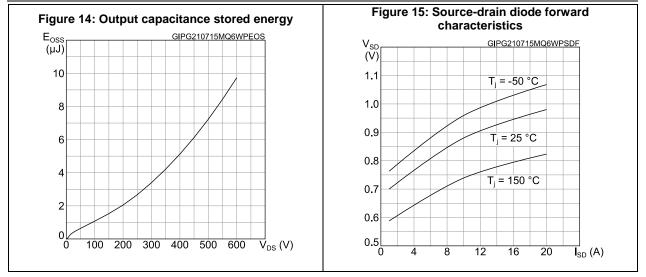






Electrical characteristics

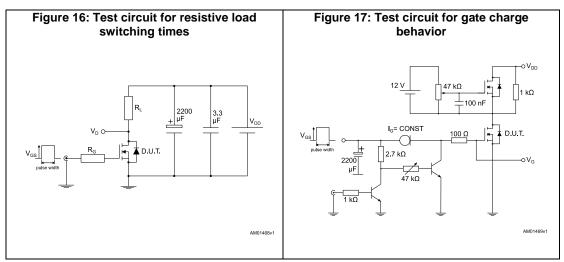
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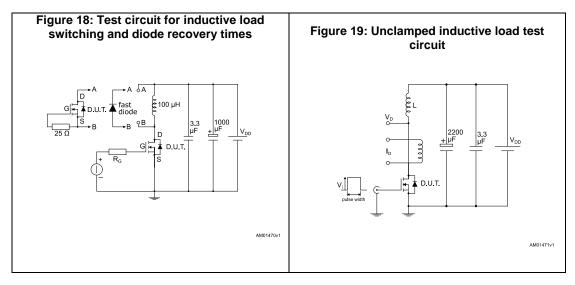


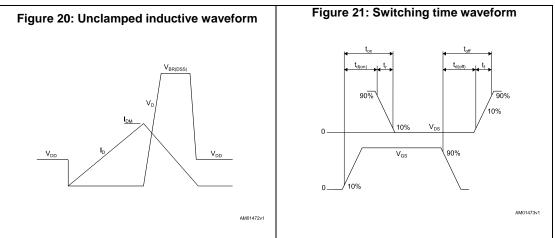


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3 Test circuits







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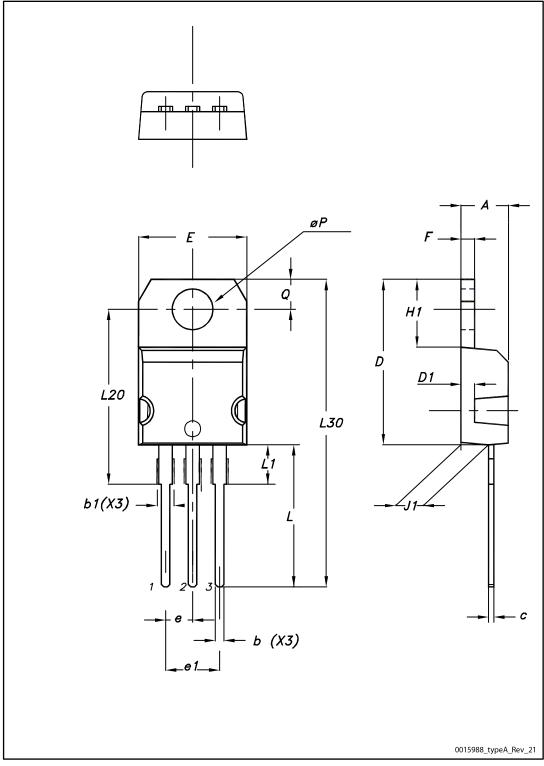
4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.



4.1 TO-220 type A package information

Figure 22: TO-220 type A package outline



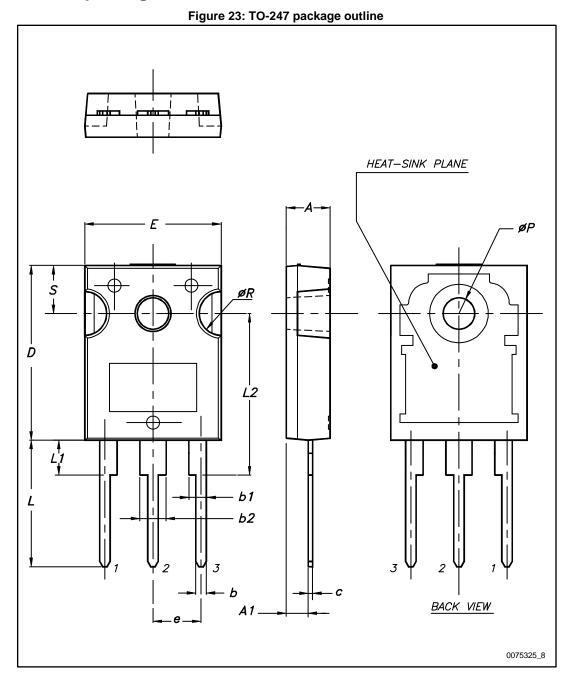


Package information

	Table 9: TO-220 typ	e A mechanical data	N60M2, STW2
Dim		mm	
Dim.	Min.	Тур.	Max.
А	4.40		4.60
b	0.61		0.88
b1	1.14		1.55
С	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10.00		10.40
е	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13.00		14.00
L1	3.50		3.93
L20		16.40	
L30		28.90	
øP	3.75		3.85
Q	2.65		2.95



4.2 TO-247 package information





Package information

STP26N60M2, STW26N60M2

nformation	51P26N60M2, 51W26N60M2			
Table 10: TO-247 package mechanical data				
Dim.	mm			
	Min.	Тур.	Max.	
А	4.85		5.15	
A1	2.20		2.60	
b	1.0		1.40	
b1	2.0		2.40	
b2	3.0		3.40	
С	0.40		0.80	
D	19.85		20.15	
E	15.45		15.75	
е	5.30	5.45	5.60	
L	14.20		14.80	
L1	3.70		4.30	
L2		18.50		
ØP	3.55		3.65	
ØR	4.50		5.50	
S	5.30	5.50	5.70	

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5 Revision history

 Table 11: Document revision history

Date	Revision	Changes	
03-Aug-2015	1	First release.	
08-Mar-2017	2	Updated Table 2: "Absolute maximum ratings", Table 3: "Thermal data" and Figure 10: "Capacitance variations". Minor text changes.	



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